

# **Enhancement Mode N-Channel Power MOSFET**

PDFN5X6/NMOS/30V/ $\pm$ 20V/1.7V/243A/0.95m $\Omega$ 

Rev<sub>0.1</sub>





# 30V, $0.95m\Omega$ , 243A, Single N-Channel

#### 1.Features

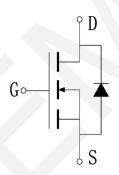
- ◆ 30V MOSFET technology
- ◆ Low on-state resistance
- Fast switching
- ♦ Vgs±20V
- ♦ 100% RG Tested
- ◆ 100% UIS Tested

| 2 An | nlica | tions  |
|------|-------|--------|
| Z.AP | piica | เเบเเอ |

- Power Switching Application
- Load Switching



| V <sub>DS</sub> | R <sub>DS(on)</sub> Typ. | I <sub>D</sub> Max. |
|-----------------|--------------------------|---------------------|
| 201/            | 0.95mΩ @ 10V             | 0.40.4              |
| 30V             | 1.2mΩ @ 4.5V             | 243A                |



Schematic Diagram

#### 3. Package Marking and Ordering Information

| Part no.   | Marking | Package | PCS/Reel | PCS/CTN. |
|------------|---------|---------|----------|----------|
| WX010N03PA | 010N03  | PDFN5X6 | 5,000    | 50,000   |

## 4.Absolute Max Ratings at Tc=25°C (Note1)

| Parameter                       | Symbol           | Maximum     | Units |
|---------------------------------|------------------|-------------|-------|
| Drain to Source Voltage         | V <sub>DSS</sub> | 30          | V     |
| Gate to Source Voltage          | V <sub>GSS</sub> | ±20         | V     |
| Drain Current (DC)              | ID               | 243         | А     |
| Drain Current (Pulse), PW≤300μs | I <sub>DP</sub>  | 972         | А     |
| Total Dissipation               | P <sub>D</sub>   | 104         | W     |
| Avalanche Energy, Single Pulsed | Eas              | 423         | mJ    |
| Junction Temperature            | Tj               | 150         | °C    |
| Storage Temperature             | T <sub>stg</sub> | -55 to +150 | °C    |

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



#### 5. Thermal Resistance Ratings (Note 2)

| Parameter        | Symbol | Value | Unit |
|------------------|--------|-------|------|
| Junction to case | Rejc   | 1.2   | °C/W |

Note 2: When mounted on 1 inch square copper board  $t \le 10$ sec The value in any given application depends on the user's specific board design.

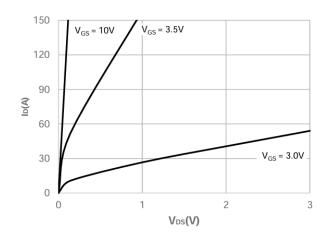
#### 6.Electrical Characteristics at Tj=25°C (Note 3)

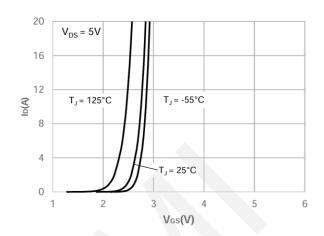
| Parameter                         | Symbol               | Test Conditions   | Min. | Тур. | Max. | Units |
|-----------------------------------|----------------------|---|------|------|------|-------|
| Drain to Source Breakdown Voltage | V <sub>(BR)DSS</sub> | $I_D = 250 \mu A$ , $V_{GS} = 0 V$                        | 30   | -    | 1    | V     |
| Zero-Gate Voltage Drain Current   | I <sub>DSS</sub>     | V <sub>DS</sub> =30V, V <sub>GS</sub> = 0V                | -    | -    | 1    | μΑ    |
| Gate to Source Leakage Current    | Igss                 | $V_{GS} = \pm 20V, V_{DS} = 0V$                           | -    | -    | ±100 | nA    |
| Gate Threshold Voltage            | $V_{GS(th)}$         | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250µA | 1.2  | 1.7  | 2.5  | V     |
| Static Drain to Source On-State   | Б                    | I <sub>D</sub> = 20A, V <sub>GS</sub> = 10V               | 1    | 0.95 | 1.2  | mΩ    |
| Resistance                        | R <sub>DS(on)</sub>  | I <sub>D</sub> = 15A, V <sub>GS</sub> = 4.5V              | -    | 1.2  | 1.6  | mΩ    |
| Input Capacitance                 | C <sub>iss</sub>     | V <sub>GS</sub> =0V,                                      | -    | 5063 | -    | pF    |
| Output Capacitance                | Coss                 | V <sub>DS</sub> =15V,                                     | -    | 3481 | -    | pF    |
| Reverse Transfer Capacitance      | Crss                 | Frequency=1.0MHz  | -    | 276  | -    | pF    |
| Turn-ON Delay Time                | t <sub>d(on)</sub>   |   | -    | 31   | -    | ns    |
| Rise Time                         | tr                   | $V_{DS} = 15V, I_{D}=15A,$                                | -    | 54   | -    | ns    |
| Turn-OFF Delay Time               | t <sub>d(off)</sub>  | $V_{GS} = 10V$ ,<br>$R_{GEN} = 3\Omega$                   | -    | 41   | -    | ns    |
| Fall Time                         | t <sub>f</sub>       |   | -    | 28   | -    | ns    |
|                                   | Qg                   | V <sub>DS</sub> = 15V,                                    | -    | 81   | -    | nC    |
| Total Gate Charge                 | Qgs                  | $V_{GS} = 0 \text{ to } 10V,$ $I_{D} = 15A$               | -    | 15   | -    | nC    |
|                                   | Q <sub>gd</sub>      |   | -    | 16   | -    | nC    |
| Diode Forward Voltage             | V <sub>FSD</sub>     | I <sub>S</sub> =20A, V <sub>GS</sub> = 0                  | 0.5  | -    | 1.2  | V     |

Note 3: Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

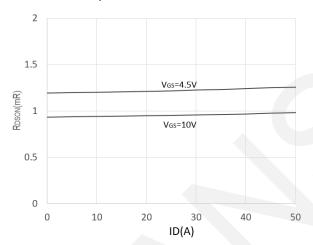


## 7. Typical electrical and thermal characteristics

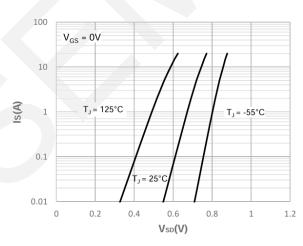




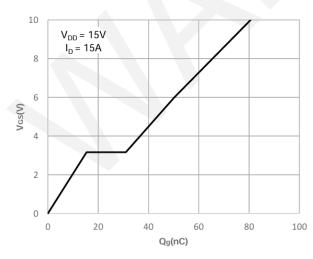
#### **Output Characteristics**



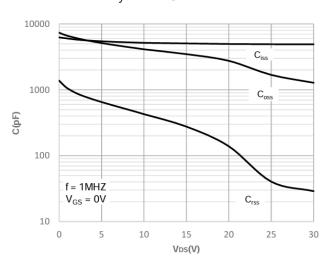
Typical Transfer Characteristics



On-resistance vs. Drain Current



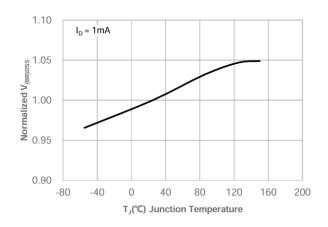
**Body Diode Characteristics** 

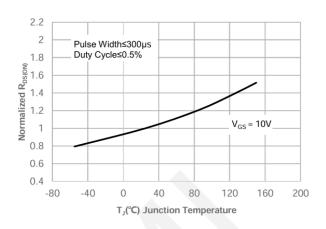


Gate Charge Characteristics

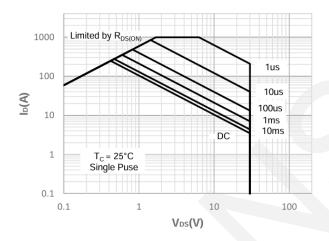
Capacitance Characteristics



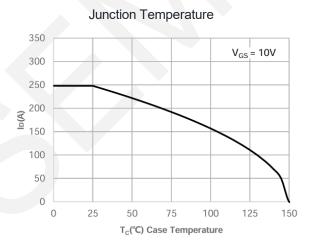




Normalized Breakdown voltage vs. Junction Temperature



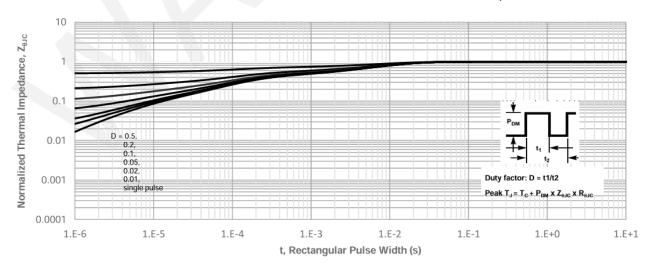
Normalized on Resistance vs.



Maximum Safe Operating Area

Maximum Continuous Drain Current vs.

Case Temperature

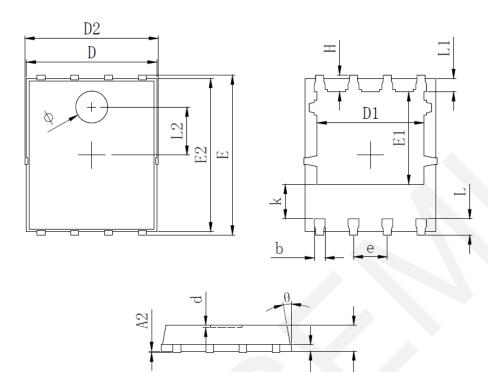


Maximum Effective Transient

Thermal Impedance, Junction-to-Case



# 8.Package Dimensions



| SYMBOL |            | MILLIMETER  |        |
|--------|------------|-------------|--------|
| SIMDOL | MIN        | Typ.        | MAX    |
| A      | 0. 900     | 1. 000      | 1. 100 |
| A1     |            | 0. 254 REF. |        |
| A2     |            | 0~0.05      |        |
| D      | 4. 824     | 4. 900      | 4. 976 |
| D1     | 3. 910     | 4. 010      | 4. 110 |
| D2     | 4. 924     | 5. 000      | 5. 076 |
| Е      | 5. 924     | 6. 000      | 6. 076 |
| E1     | 3. 375     | 3. 475      | 3. 575 |
| E2     | 5. 674     | 5. 750      | 5. 826 |
| ъ      | 0. 350     | 0. 400      | 0. 450 |
| е      | 1.270 TYP. |             |        |
| L      | 0. 534     | 0. 610      | 0.686  |
| L1     | 0. 424     | 0. 500      | 0. 576 |
| L2     | 1.800 REF. |             |        |
| k      | 1. 190     | 1. 290      | 1. 390 |
| Н      | 0. 549     | 0. 625      | 0. 701 |
| θ      | 8°         | 10°         | 12°    |
| ф      | 1. 100     | 1. 200      | 1.300  |
| d      |            |             | 0. 100 |



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